

# 2SK2129

## Silicon N-Channel Power F-MOS FET

## ■ Features

- Avalanche energy capacity guaranteed: EAS > 20mJ
  - $V_{GSS} = \pm 30V$  guaranteed
  - High-speed switching:  $t_f = 50\text{ns}$
  - No secondary breakdown

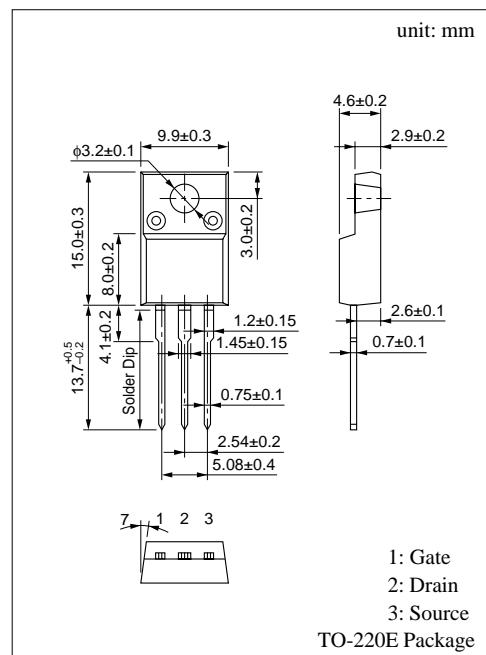
## ■ Applications

- Contactless relay
  - Driving circuit for a solenoid
  - Driving circuit for a motor
  - Control equipment
  - Switching power supply

#### ■ Absolute Maximum Ratings ( $T_C = 25^\circ\text{C}$ )

Parameter	Symbol	Ratings	Unit
Drain to Source breakdown voltage	V <sub>DSS</sub>	800	V
Gate to Source voltage	V <sub>GSS</sub>	±30	V
Drain current	DC	I <sub>D</sub>	±3
	Pulse	I <sub>DP</sub>	±6
Avalanche energy capacity	EAS*	20	mJ
Allowable power dissipation	T <sub>C</sub> = 25°C	P <sub>D</sub>	50
	T <sub>a</sub> = 25°C		2
Channel temperature	T <sub>ch</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

\* L = 4.5mH, I<sub>L</sub> = 3A, V<sub>DD</sub> = 50V, 1 pulse



### ■ Electrical Characteristics ( $T_C = 25^\circ\text{C}$ )

Parameter	Symbol	Conditions	min	typ	max	Unit
Drain to Source cut-off current	I <sub>DSS</sub>	V <sub>DS</sub> = 640V, V <sub>GS</sub> = 0			0.1	mA
Gate to Source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±30V, V <sub>DS</sub> = 0			±1	µA
Drain to Source breakdown voltage	V <sub>DSS</sub>	I <sub>D</sub> = 1mA, V <sub>GS</sub> = 0	800			V
Gate threshold voltage	V <sub>th</sub>	V <sub>DS</sub> = 25V, I <sub>D</sub> = 1mA	2		5	V
Drain to Source ON-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 2A		3.2	4	Ω
Forward transfer admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 25V, I <sub>D</sub> = 2A	1.5	2.4		S
Diode forward voltage	V <sub>DSF</sub>	I <sub>DR</sub> = 3A, V <sub>GS</sub> = 0			-1.6	V
Input capacitance (Common Source)	C <sub>iss</sub>	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0, f = 1MHz		730		pF
Output capacitance (Common Source)	C <sub>oss</sub>			90		pF
Reverse transfer capacitance (Common Source)	C <sub>rss</sub>			40		pF
Turn-on time (delay time)	t <sub>d(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 2A V <sub>DD</sub> = 200V, R <sub>L</sub> = 100Ω		35		ns
Rise time	t <sub>r</sub>			60		ns
Fall time	t <sub>f</sub>			50		ns
Turn-off time (delay time)	t <sub>d(off)</sub>			160		ns
Thermal resistance between channel and case	R <sub>th(ch-c)</sub>				2.5	°C/W

